



US00D811340S

(12) **United States Design Patent** (10) **Patent No.:** **US D811,340 S**  
**Zhu** (45) **Date of Patent:** **\*\* Feb. 27, 2018**

(54) **CONDUCTIVE PLATE**(71) Applicant: **SHANUTEC (SHANGHAI) CO., LTD.**, Shanghai (CN)

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(\*\*) Term: **15 Years**(21) Appl. No.: **29/569,884**(57) **CLAIM**(22) Filed: **Jun. 30, 2016**

The ornamental design for a conductive plate, as shown and described.

(51) LOC (11) Cl. ..... **13-03**

(52) U.S. Cl.

USPC ..... **D13/146**(58) **Field of Classification Search**

USPC ..... D13/128, 129, 130, 131, 132, 133, 146,

D13/147, 154, 182, 184, 199

CPC ..... H01R 24/00; H01R 24/78; H01R 25/14;

H01R 25/142; H01R 25/16; H01R 25/162

See application file for complete search history.

**DESCRIPTION**

FIG. 1 is a perspective view of a conductive plate showing my new design;

FIG. 2 is a front view thereof;

FIG. 3 is a rear view thereof;

FIG. 4 is a right view thereof;

FIG. 5 is a left view thereof;

FIG. 6 is a top view thereof; and,

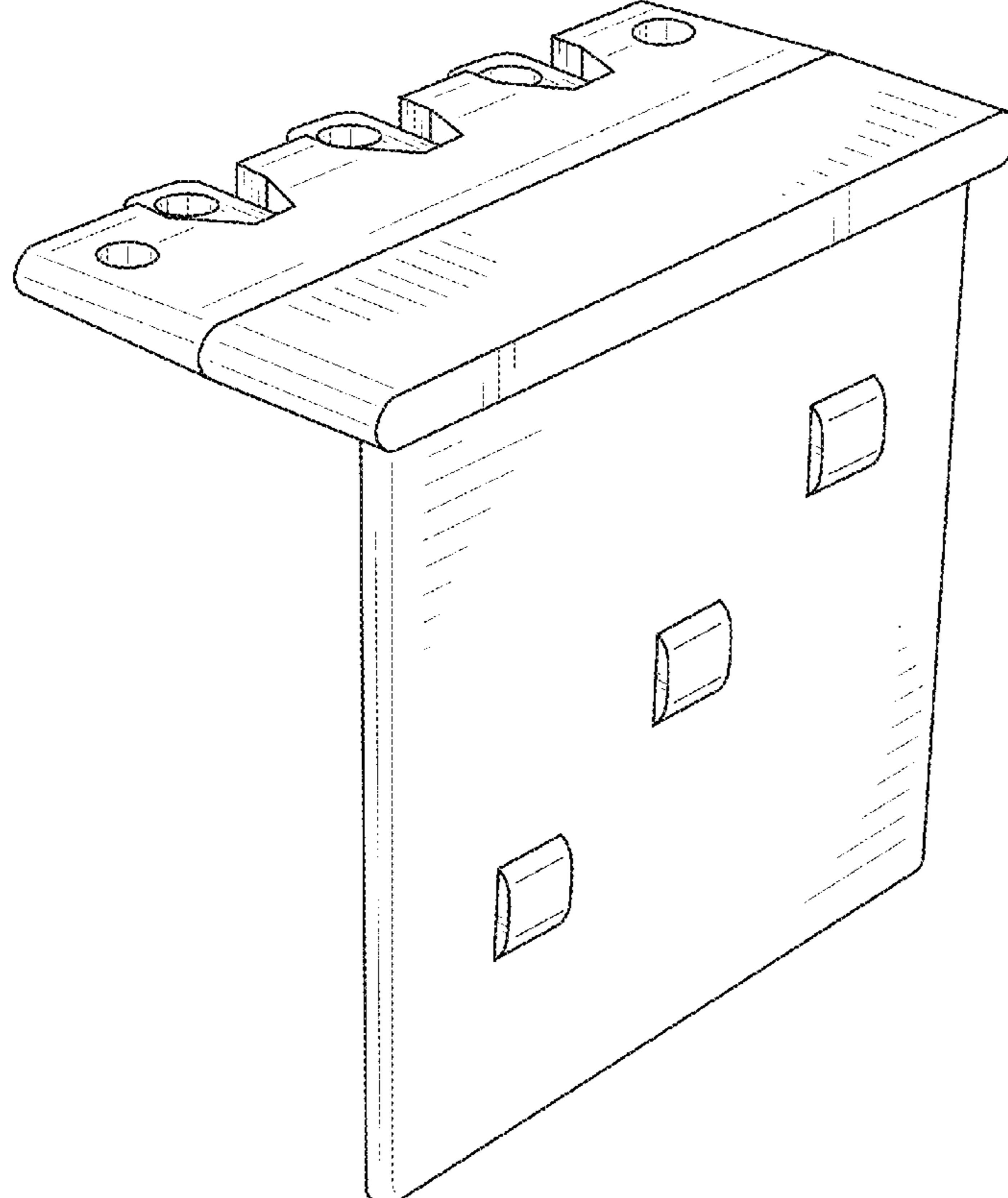
FIG. 7 is a bottom view thereof.

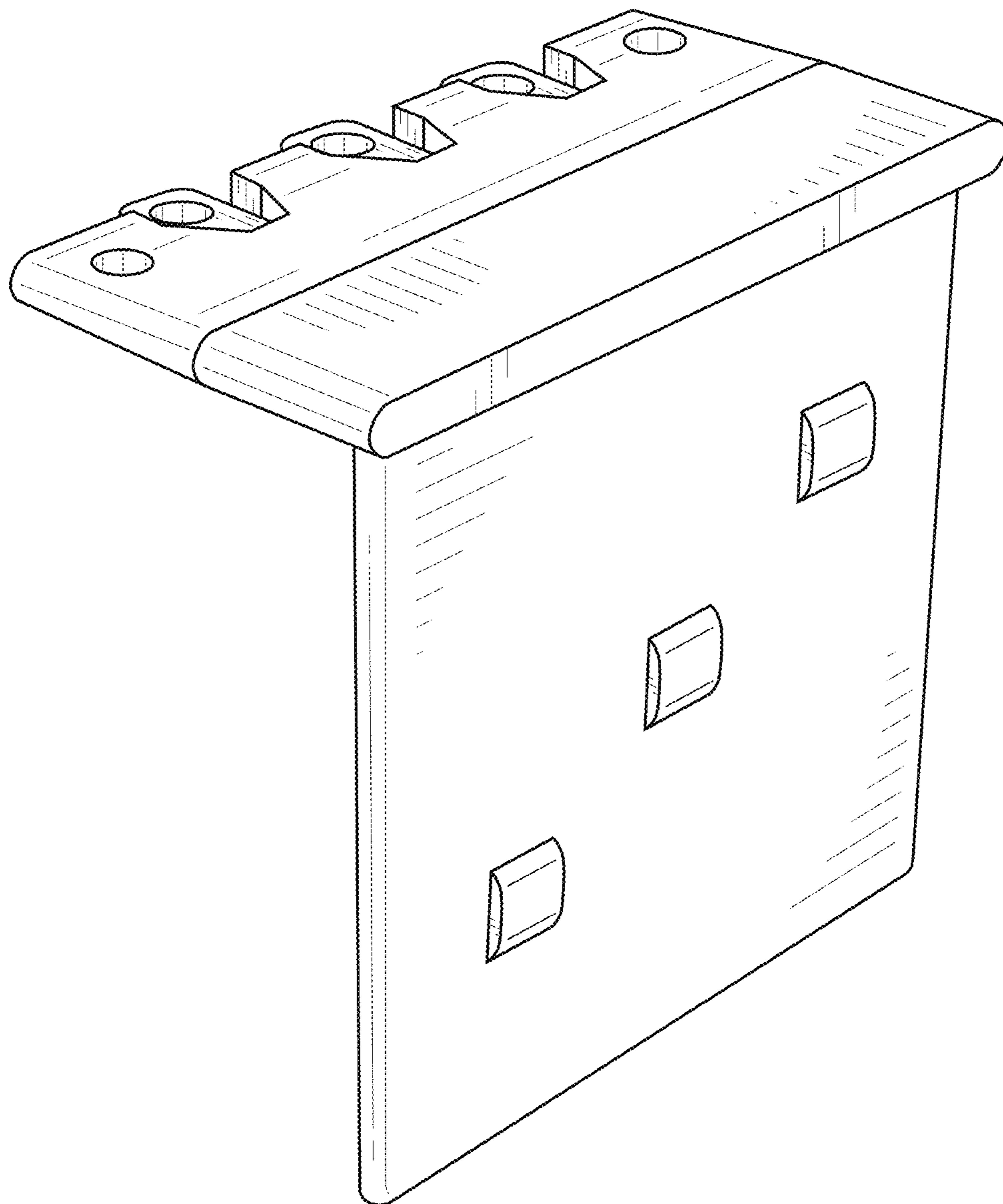
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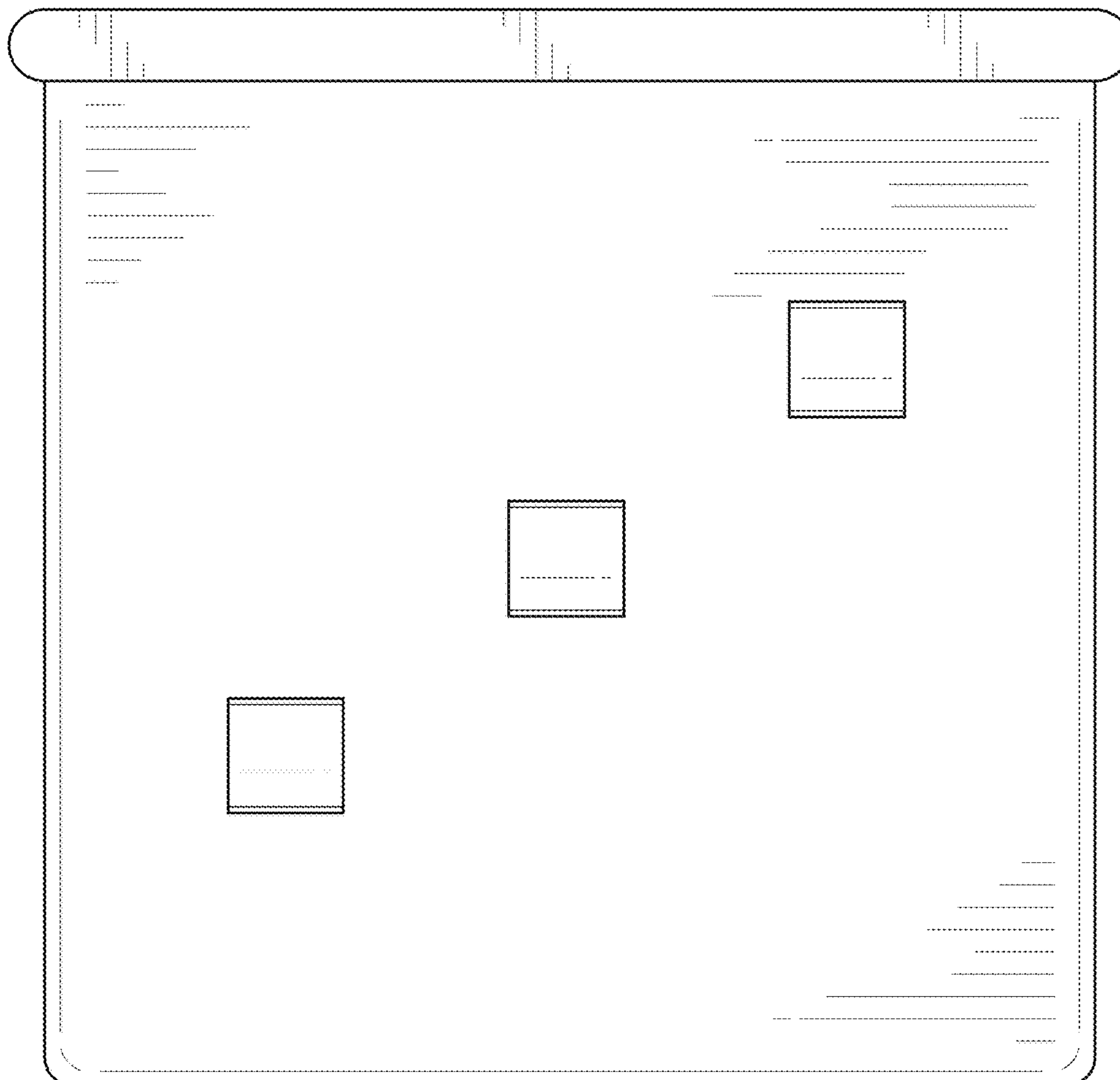
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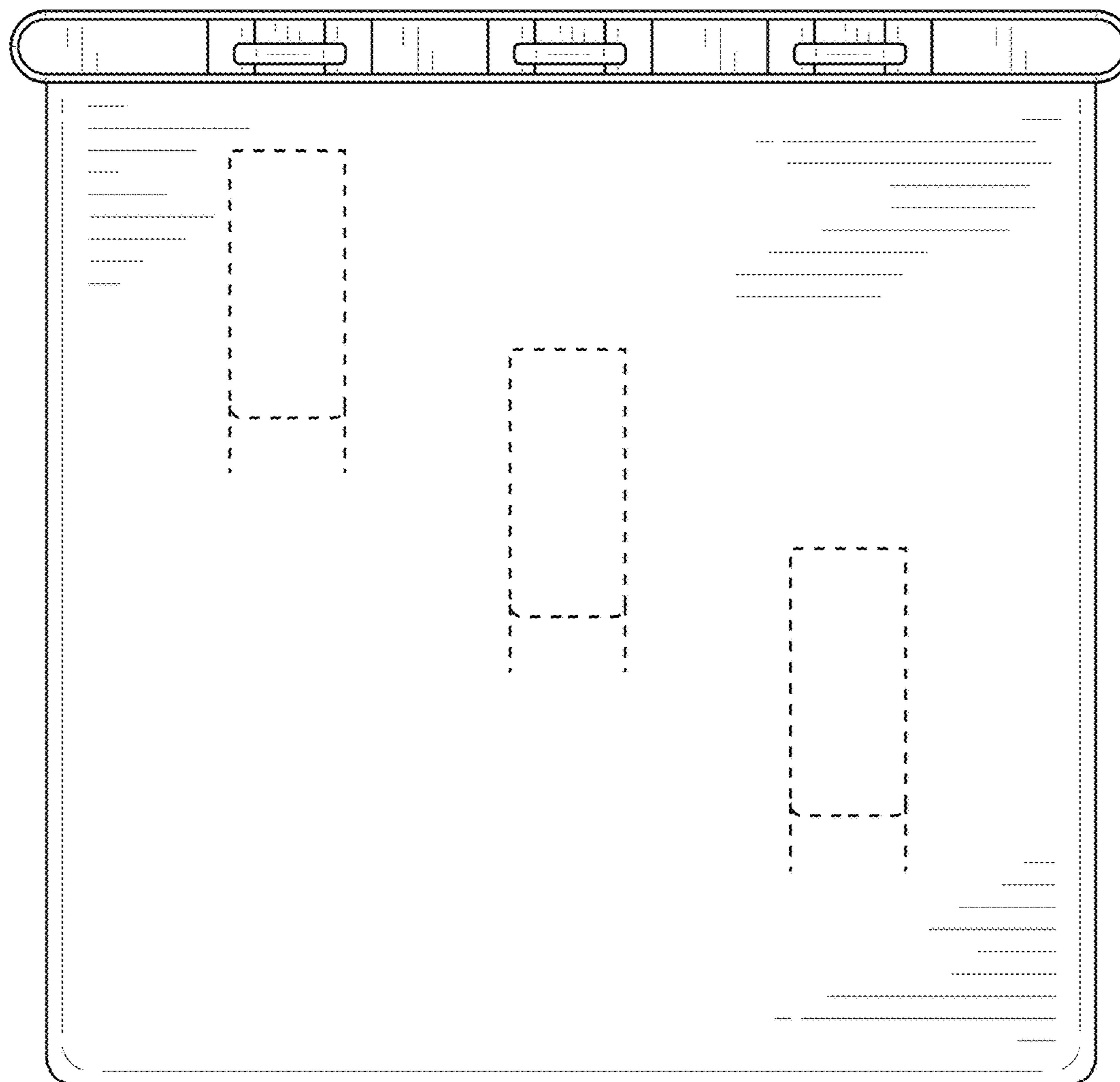
**1 Claim, 7 Drawing Sheets**



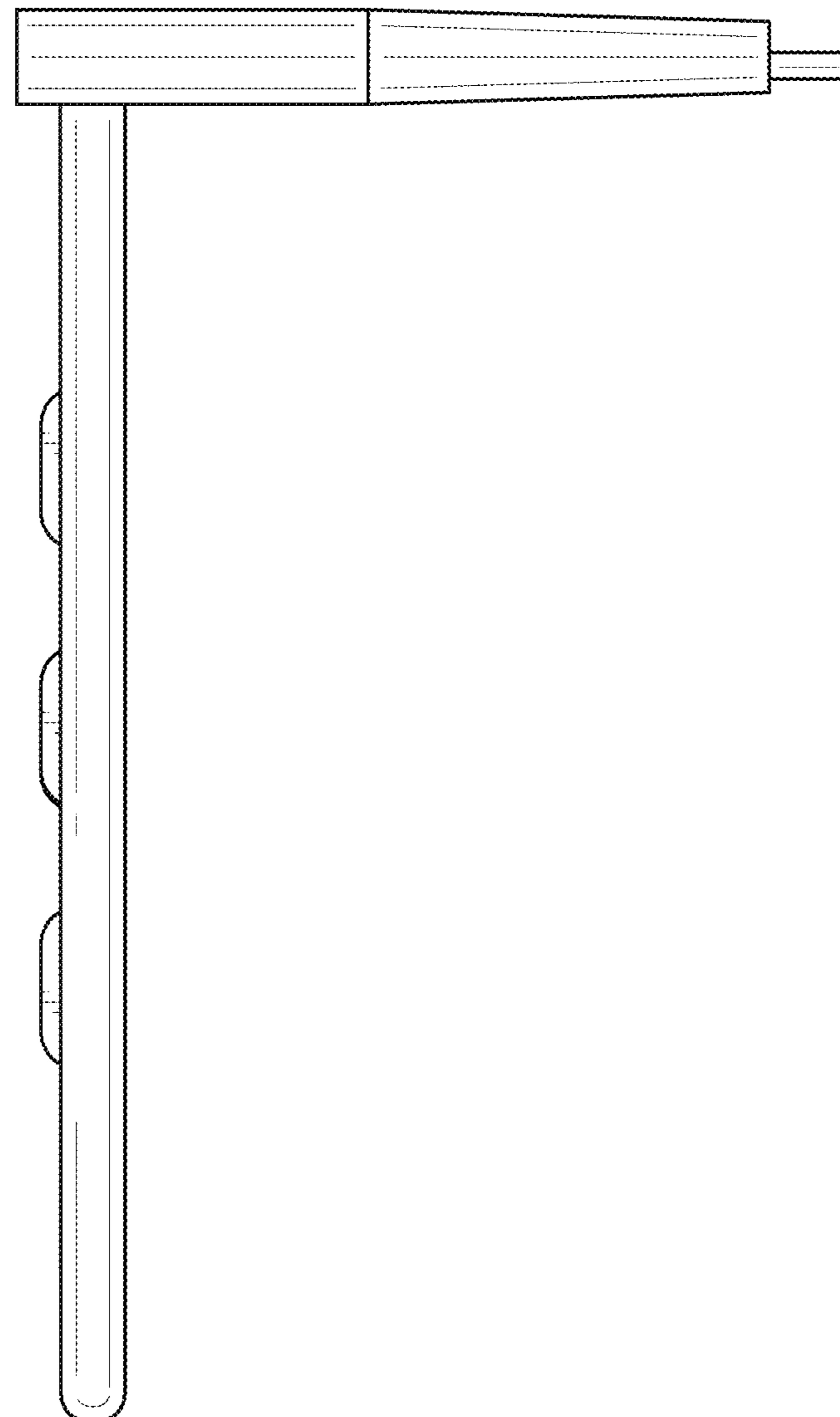
**FIG. 1**



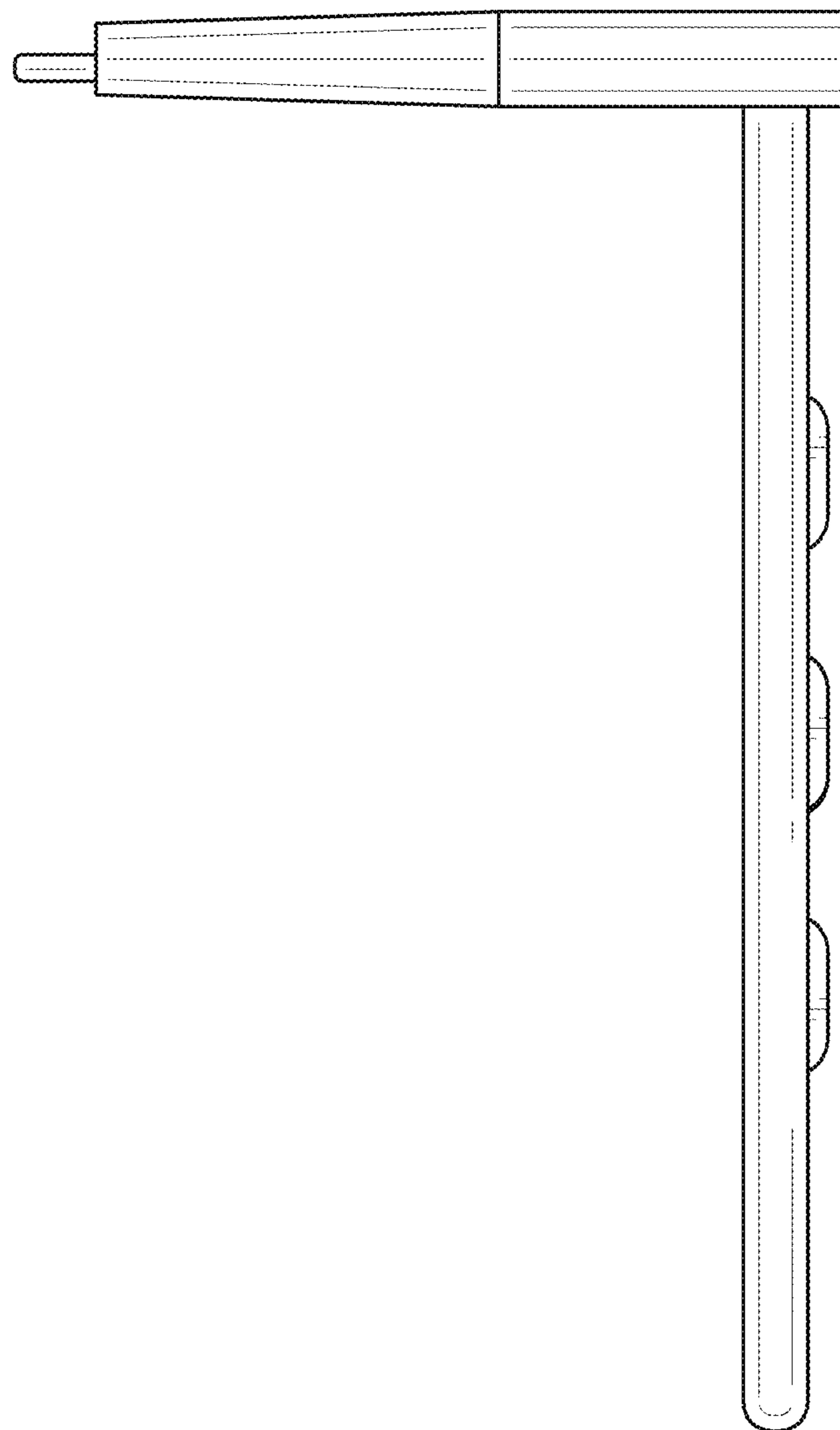
**FIG. 2**



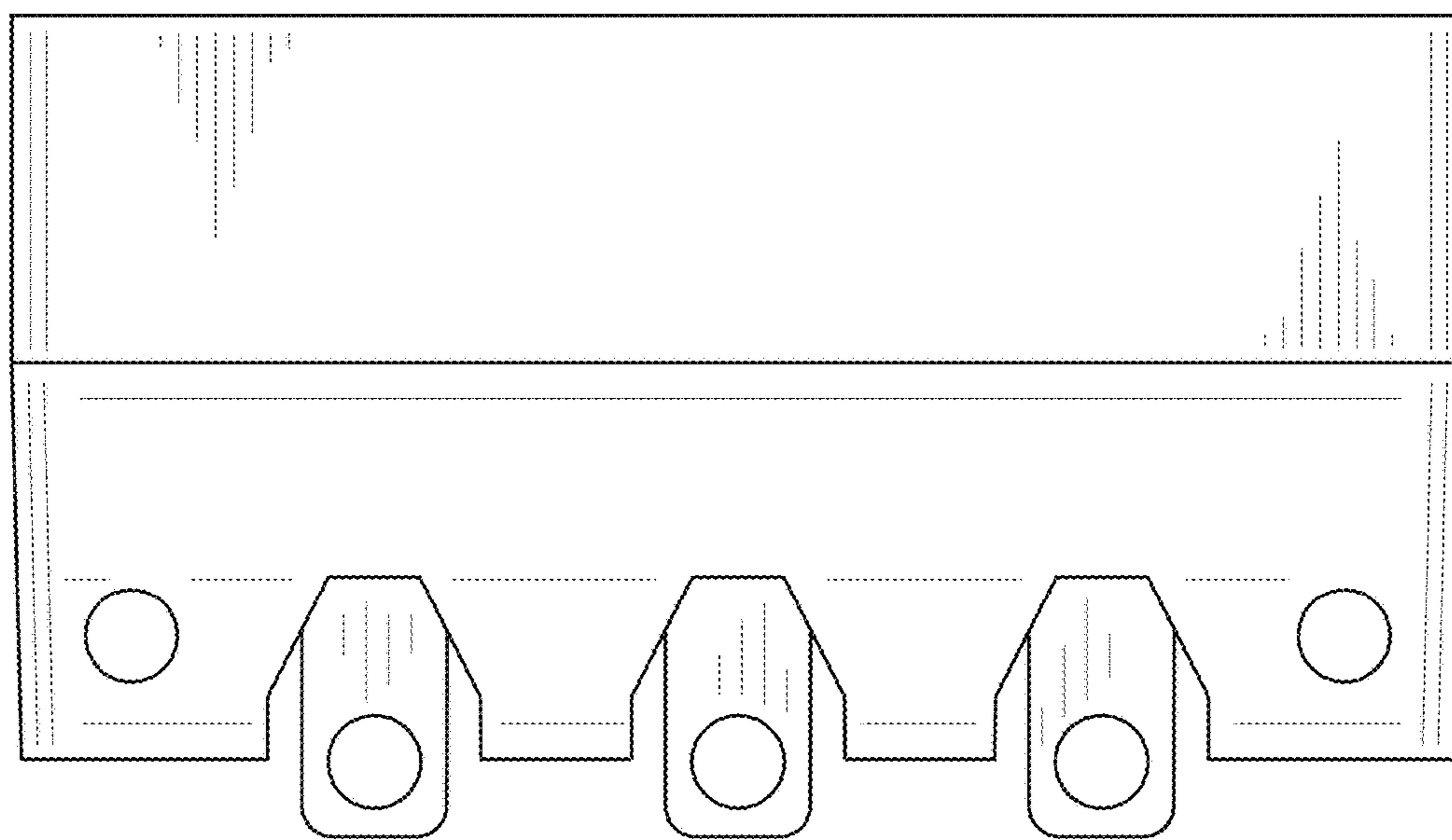
**FIG. 3**



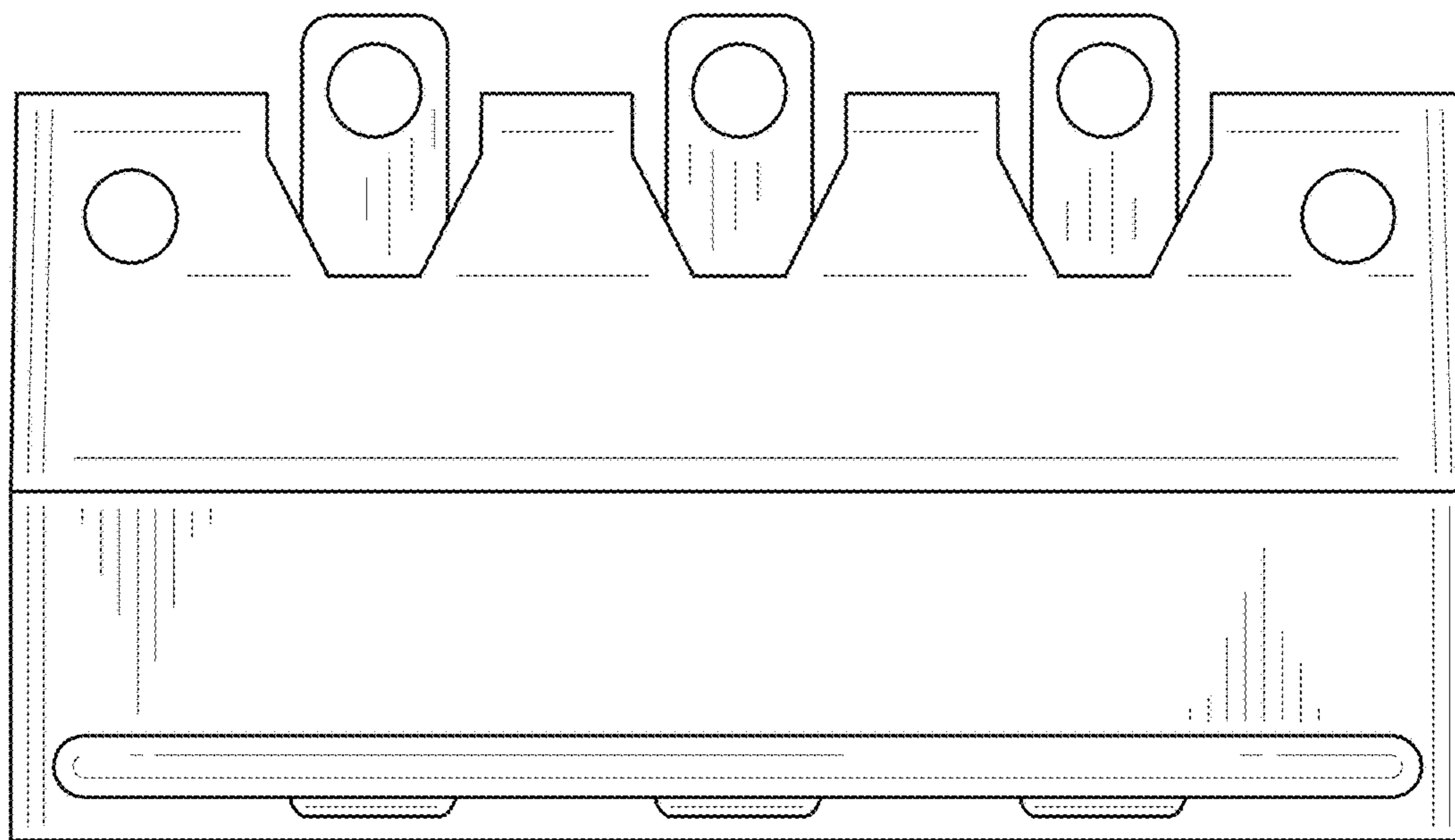
***FIG. 4***



***FIG. 5***



**FIG. 6**



**FIG. 7**